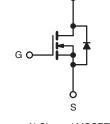


## **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	60				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 5.0 V 0.10				
Q <sub>g</sub> (Max.) (nC)	18				
Q <sub>gs</sub> (nC)	4.5				
Q <sub>gd</sub> (nC)	12				
Configuration	Single				





N-Channel MOSFET

D

### FEATURES

- Dynamic dV/dt Rating
- For Automatic Insertion
- End Stackable
- Logic-Level Gate Drive
- R<sub>DS(on)</sub> Specified at V<sub>GS</sub> = 4 V and 5 V
- 175 °C Operating Temperature
- · Fast Switching
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertiable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain servers as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION		
Package	HVMDIP	
Lead (Pb)-free	IRLD024PbF	
	SiHLD024-E3	
SnPb	IRLD024	
	SiHLD024	

ABSOLUTE MAXIMUM RATINGS (	T <sub>A</sub> = 25 °C, ι	Inless other	wise noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	60	v	
Gate-Source Voltage			V <sub>GS</sub>	± 10	v	
Continuous Drain Current	Vac of E.O.V	T <sub>A</sub> = 25 °C	– I <sub>D</sub>	2.5		
Continuous Drain Current	V <sub>GS</sub> at 5.0 V	T <sub>A</sub> = 100 °C		1.8	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	20	1	
Linear Derating Factor				0.0083	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	91	mJ	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C		PD	1.3	W	
Peak Diode Recovery dV/dt <sup>c</sup>		dV/dt	4.5	V/ns		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175			
Soldering Recommendations (Peak Temperature)	for	for 10 s		300 <sup>d</sup>	°C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD}$  = 25 V, starting T<sub>J</sub> = 25 °C, L = 16 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 2.5 A (see fig. 12).

c.  $I_{SD} \leq 17$  A,  $dI/dt \leq 140$  A/µs,  $V_{DD} \leq V_{DS}, \, T_J \leq 175 \ ^{\circ}C.$ 

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply





PARAMETER	SYMBOL	TYP		MAX.			UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 120			°C/W				
SPECIFICATIONS (T <sub>J</sub> = 25 °C,	unless other	wise noted)							
PARAMETER	SYMBOL	TES		ONS	MIN.	TYP.	MAX.	UNI	
Static									
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	50 µA	60	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, l	<sub>D</sub> = 1 mA	-	0.060	-	V/°0	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	50 µA	1.0	-	2.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 10 \	/	-	-	± 100	nA	
Zene Osta Maltana Durin Ormani		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	25			
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 48 V	$V_{GS} = 0 V,$	T <sub>J</sub> = 150 °C	-	-	250	μA	
	5	V <sub>GS</sub> = 5.0 V	I <sub>D</sub>	= 1.5A <sup>b</sup>	-	-	0.10		
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.0 V	I <sub>D</sub> :	= 1.3 A <sup>b</sup>	-	-	0.14	Ω	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	= 25 V, I <sub>D</sub> = <sup>-</sup>	1.5 A <sup>b</sup>	3.7	-	-	S	
Dynamic								1	
Input Capacitance	C <sub>iss</sub>		$V_{22} = 0 V_{22}$		-	870	-		
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V V_{DS} = 25 V f = 1.0 MHz, see fig. 5$		-	360	-	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	53	-			
Total Gate Charge	Qg	V <sub>GS</sub> = 5.0 V I <sub>D</sub> = 17 A, V <sub>DS</sub> = 48 V see fig. 6 and 13 <sup>b</sup>			-	-	18		
Gate-Source Charge	Q <sub>gs</sub>			-	-	4.5	nC		
Gate-Drain Charge	Q <sub>gd</sub>		see fig. 6 and 130		-	-	12	1	
Turn-On Delay Time	t <sub>d(on)</sub>		1		-	11	-		
Rise Time	t <sub>r</sub>	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 17 A		-	110	-	1		
Turn-Off Delay Time	t <sub>d(off)</sub>			see fig. 10 <sup>b</sup>	-	23	-	ns	
Fall Time	t <sub>f</sub>			-	41	-	1		
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-			
Internal Source Inductance	L <sub>S</sub>			-	6.0	-	nH		
Drain-Source Body Diode Characteristic	s								
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the		-	-	2.5	A		
Pulsed Diode Forward Currenta	I <sub>SM</sub>	p - n junction diode			-	-	20		
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	, I <sub>S</sub> = 2.5 A,	V <sub>GS</sub> = 0 V <sup>b</sup>	-	-	1.5	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- $T_J = 25 \text{ °C}, I_F = 17 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^b$		-	110	260	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			π = 100 A/μs <sup>o</sup>	-	0.49	1.5	μΟ	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	Irn-on time is	s negligible (turn	on is dor	ninated by	/ L <sub>S</sub> and I	_D)	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300  $\mu s;$  duty cycle  $\leq$  2 %.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

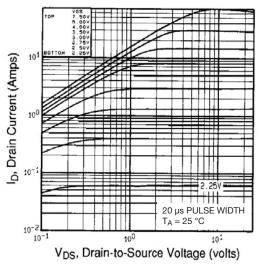


Fig. 1 - Typical Output Characteristics,  $T_A = 25$  °C

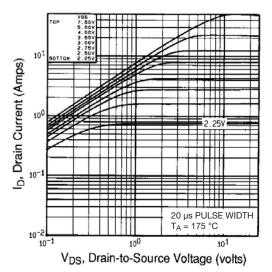


Fig. 2 - Typical Output Characteristics,  $T_A = 175 \ ^{\circ}C$ 

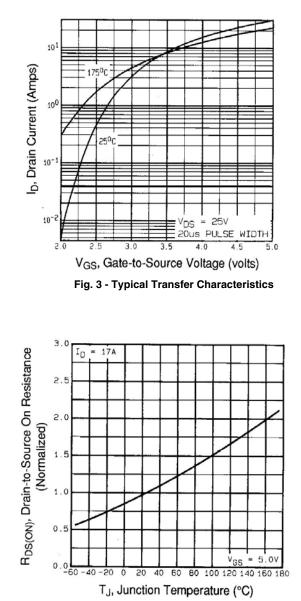


Fig. 4 - Normalized On-Resistance vs. Temperature

## Vishay Siliconix



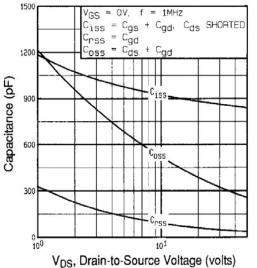


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

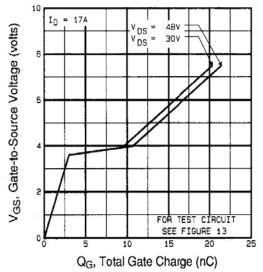


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

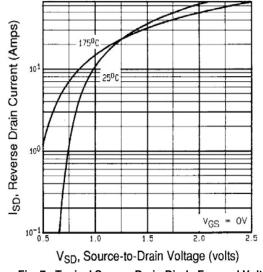


Fig. 7 - Typical Source-Drain Diode Forward Voltage

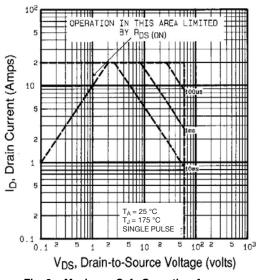


Fig. 8 - Maximum Safe Operating Area



### Vishay Siliconix

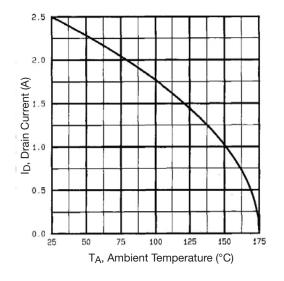


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

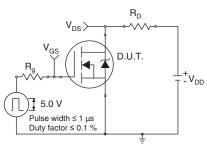


Fig. 10a - Switching Time Test Circuit

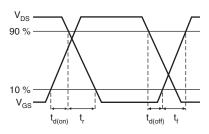


Fig. 10b - Switching Time Waveforms

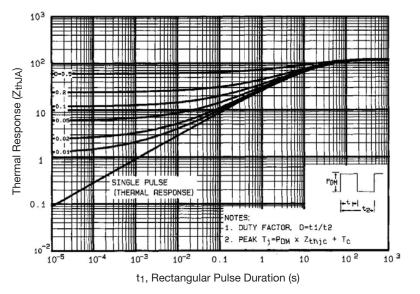


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

### Vishay Siliconix



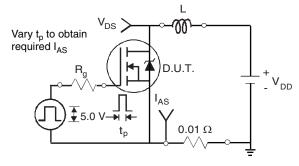


Fig. 12a - Unclamped Inductive Test Circuit

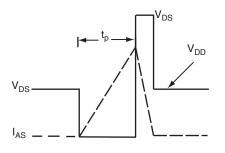
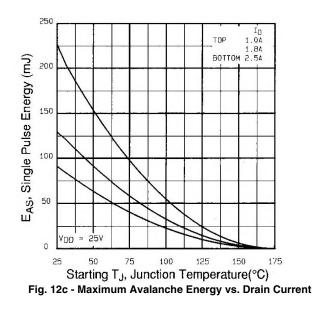
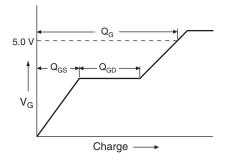


Fig. 12b - Unclamped Inductive Waveforms







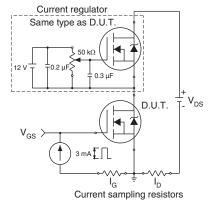


Fig. 13b - Gate Charge Test Circuit



### **Vishay Siliconix**

#### Peak Diode Recovery dV/dt Test Circuit

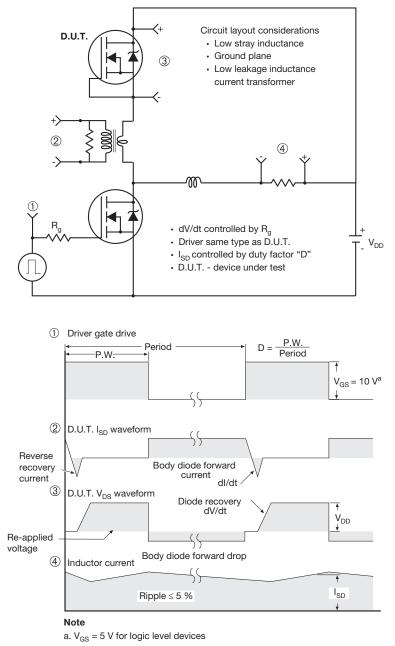


Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?91308">www.vishay.com/ppg?91308</a>.



#### HVM DIP (High voltage)





	INCHES		MILLIN	IETERS
DIM.	MIN.	MAX.	MIN.	MAX.
А	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36
ECN: X10-0386-Rev. B, 0 DWG: 5974	06-Sep-10			

Note

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.



Vishay

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